

Introduction

- MEMS devices exist in a three-dimensional physical continuum and their behavior is governed by the laws of physics, chemistry, and biology.
- Through analysis, we can extract simplified device representations that are readily expressible with equivalent electrics circuits.
- Circuit analogies also permit efficient modeling of the interaction between the electronic and the non-electronic components of a microsystem.
- Unlike 3D physical objects, which are bounded by surfaces, circuit elements are abstractions that have two or more discrete *terminals* to which potential difference (voltage) can be applied and into which electric currents can flow.
- Kirchhoff's Laws govern the relationships among the voltages and currents that must be satisfied when circuit elements are connected into complete circuits.





Conjugate Power Variables (ctnd.)								
<i>Table 5.1.</i> Examples of conjugate power variables.								
Energy Domain	Effort	Flow	Momentum	Displacemen				
Mechanical translation	Force F	Velocity \dot{x}, v	Momentum p	Position x				
Fixed-axis rotation	Torque $ au$	Angular velocity ω	Angular momentum J	Angle θ				
Electric circuits	Voltage V, v	Current I, i		Charge Q				
Magnetic circuits	Magnetomotive force MMF	Flux rate $\dot{\phi}$	•••	Flux Ø				
Incompressible fluid flow	Pressure P	Volumetric flow Q	Pressure momentum Γ	Volume V				
Thermal	Temperature T	Entropy flow rate \dot{S}	•••	Entropy S				





	Tabl	Table 5.2. Different conventions for assigning circuit variables.				
	Convention	Across Variable	Through Variable	Product	Principal Use	
	$e \rightarrow V$	е	f	power	electric circuit elements	
	$f \rightarrow V$	f	e	power	mechanical circuit element	
	Thermal	Т	Q	Watt-Kelvin	thermal circuits	
	HDL	q	e	energy	HDL circuit representation of mechanical elements	
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• In the thermal energy domain, while temperature ${\bf T}$ is a perfectly good across variable, the entropy flow rate turns out not to be a good choice for the through variable. Instead, we use the heat current $\dot{{\bf Q}}$, which has units of Watts.



- Figure 5.3 shows two independent source elements, a *flow source* and an effort source (analogous to current and voltage sources in electrical circuits).
- The definition of the effort source is that the effort e equals the source value $e_{\rm o}(t)$ for any flow f .
- The flow source (assuming it is connected to a network that provides a path for the flow) is defined as having a flow f equal to the source value $f_{\rm o}(t)$ for any value of the effort e.
- These are clearly *active* elements, in that they supply power to the other elements whenever the product of f and e is negative.







other elements. In this case, the element is considered an active element.















Circuit Connections in the e ->V Convention
Perhaps the most difficult aspect of using lumped circuit elements to build device macro-models is to determine how to connect them together.
We are all familiar with series and parallel connections for electrical elements.
But how do these apply to mechanical or other elements?
There are two basic concepts that hold for the e→V convention:
Shared Flow and Displacement: Elements that share a common flow, and hence a common variation of displacement, are connected *in series.* Shared Effort: Elements that share a common effort are connected *in parallel*.



- The mass is connected via a spring to a fixed support, being pulled by a force ${\boldsymbol{F}}$.
- Also shown is a *dashpot*, a mechanical damping element analogous to an electrical resistor.
- All three elements share the same displacement.
- Using the reasoning above, all three elements should be connected in series.

























